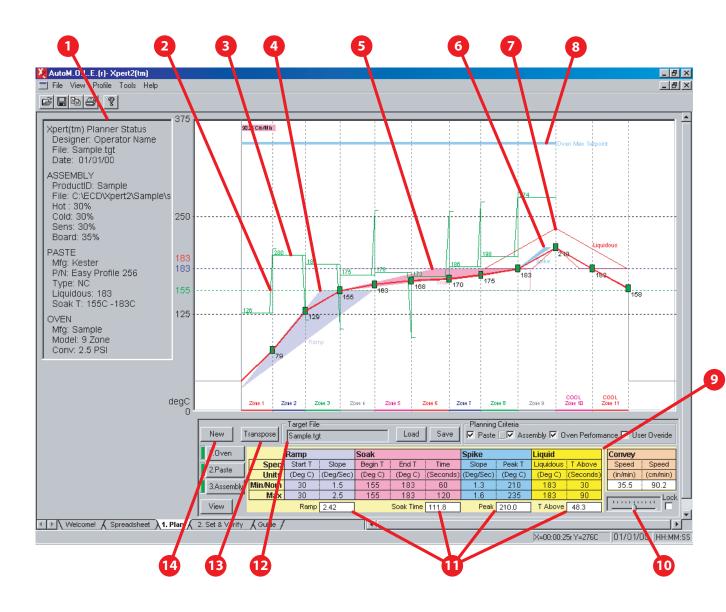


## QUICK STUDY GUIDE



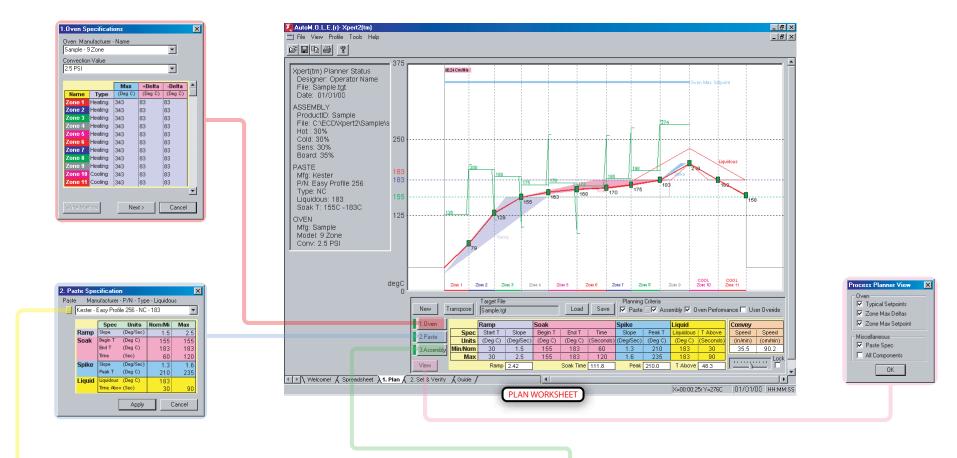
- **1 Target Profile Parameters:** This Status box contains information about the designed Robust Profile.
- **2 Zone Max. Deltas:** Largest zone temp. setpoint difference the oven allows
- **3 Typical Setpoints:** These are a range of Setpoints based on a .062" (1.6mm) board.
- Paste Spec. Ramp: The straight-line slope in degrees per second measured from the intersection of the Process Origin and the Start Temp to where the profile reaches the Soak Begin Temp.
- **Paste Spec. Soak:** The number of profile temperature values that fall between Soak Begin Temp and Soak End Temp Times the log interval.
- Paste Spec. Spike: The straight line slope in degrees per second measured from where the profile reaches the Soak End Temp to where the profile reaches a Peak temp value.
- Paste Spec. Liquidous: The amount of time the profile spends above the solder liquidous temperature.
- **B Zone Max. Setpoint:** The highest zone setpoint that the oven allows.
- **Paste Spec. Summary:** The summary of the selected Target Profile paste.
- **Speed Adjust:** Manually adjusts the oven conveyor speed for the Target Profile.
- **Robust Profile Actuals:** Profile Parameters extracted from the Robust Profile.
- Target File Management: Where the user
- Loads and Saves Target Profiles.
- **Transpose Profile Wizard:** A wizard that guides a user when creating a new Target Profile from an existing profile (MDM file).

New Target Profile Wizard: A wizard that

guides a user when creating a new Target Profile.



## QUICK STUDY GUIDE



GEN_MFG	GEN_P/N	GEN_TYPE	GEN_LIQU	RAMP_MI	RAMP_M	RAMP_RE	RAMP_NC	s_
General	General	General	General	Ramp	Ramp	Ramp	Ramp	Τ-
Manufacturer	P/N	Туре	Liquidous	Min	Max	Ref	Nom	N
			Deg C	C/Sec	C/Sec	C/Sec	C/Sec	
IM	251	NC	183	2	3	2.5	2.5	1:
IM	251(Ag)	NC	179	2	3	2.5	2.5	1:
IM	291AX	NC	183	2	3	2.5	2.5	1:
IM	291AX(Ag)	NC	179	2	3	2.5	2.5	1:
JM	293DX	NC	183	2	3	2.5	2.5	1:
JM	293DX(Ag)	NC	179	2	3	2.5	2.5	1:
IM	293+	NC	183	2	3	2.5	2.5	1:
IM	293+(Ag)	NC	179	2	3	2.5	2.5	1:
Y	207DV	NC	400	h	2	25	25	
1								· .

Component	Hot Cold Sensitive
Max-Ramp(deg/sec)	4.0 4.0 3.5 Sample
Peak(deg C)	350 350 300
Image: Syncronize   PLCC BGA>1"x1"   PLCS8 BGA>1"x1"   QFP272 TSOP64   QFP268 BGA<1"x1"   QFP56 PQFP   QFP48 SOIC28   YO252 SOIC16	Heb? Load Board Trickness 3.2mm (J.257) 2.4mm 2.4mm (J.257) 2.4mm
1204 SOT223 0804 SOT143 0402 SOT23 SOD123	

